



ACE13417B

P-Channel Enhancement Mode Power MOSFET

Description

The ACE13417B uses advanced trench technology to provide excellent R_{DS} , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

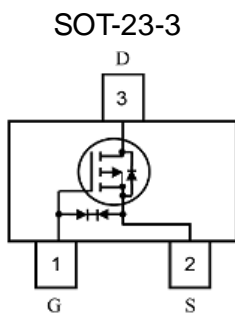
Features

- $V_{DS} (V) = -20V, I_D = -4.9A$
- $R_{DS(ON)} = 34m\Omega @ V_{GS} = -4.5V$
- $R_{DS(ON)} = 42m\Omega @ V_{GS} = -2.5V$

Absolute Maximum Ratings

Parameter	Symbol	Max	Unit
Drain-Source Voltage	V_{DSS}	-20	V
Gate-Source Voltage	V_{GSS}	± 12	V
Drain Current (Continuous)	I_D	$T_A = 25^\circ C$	-4.9
		$T_A = 70^\circ C$	-3.9
Drain Current (Pulsed)	I_{DM}	-19.7	A
Power Dissipation	P_D	1.6	W
Operating temperature / storage temperature	T_J / T_{STG}	-55~150	$^\circ C$

Packaging Type



Pin Configurations

SOT-23-3	Description	Function
1	G	Gate
2	S	Source
3	D	Drain

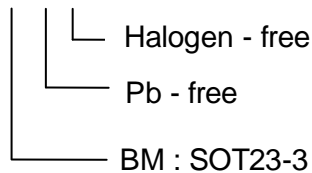


ACE13417B

P-Channel Enhancement Mode Power MOSFET

Ordering information

ACE13417B XX + H



Electrical Characteristics

T_A=25°C, unless otherwise specified.

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
ON/OFF Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -16V, V _{GS} = 0V			-1	μA
Gate Threshold Voltage	V _{GS(th)}	V _{GS} = V _{DS} , I _{DS} = -250μA	-0.45	-0.7	-1	V
Gate Leakage Current	I _{GSS}	V _{GS} = ±10V, V _{DS} = 0V			±100	nA
Drain-Source On-state Resistance	R _{DS(on)}	V _{GS} = -4.5V, I _D = -4.9A		34	43	mΩ
		V _{GS} = -2.5V, I _D = -3.1A		42	60	mΩ
Forward Transconductance	g _{FS}	V _{DS} = -5V, I _D = -2A	6			S
Diode Forward Voltage	V _{SD}	I _{SD} = -1.6A, V _{GS} = 0V			-1.2	V
Switching Characteristics						
Total Gate Charge	Q _g	V _{DS} = -10V, I _D = -4.9A, V _{GS} = -4.5V		8		nC
Gate-Source Charge	Q _{gs}			1.6		nC
Gate-Drain Charge	Q _{gd}			1.9		nC
Turn-on Delay Time	t _{d (on)}	V _{DD} = -10V, R _L = 10Ω, I _D = -1A, V _{GEN} = -4.5V, R _G = 6Ω		8		ns
Turn-on Rise Time	t _r			12.8		ns
Turn-off Delay Time	t _{d (off)}			33		ns
Turn-off Fall Time	t _f			18		ns
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = -10V, f = 1.0MHz		815		pF
Output Capacitance	C _{oss}			145		pF
Reverse Transfer Capacitance	C _{rss}			110		pF

Note :

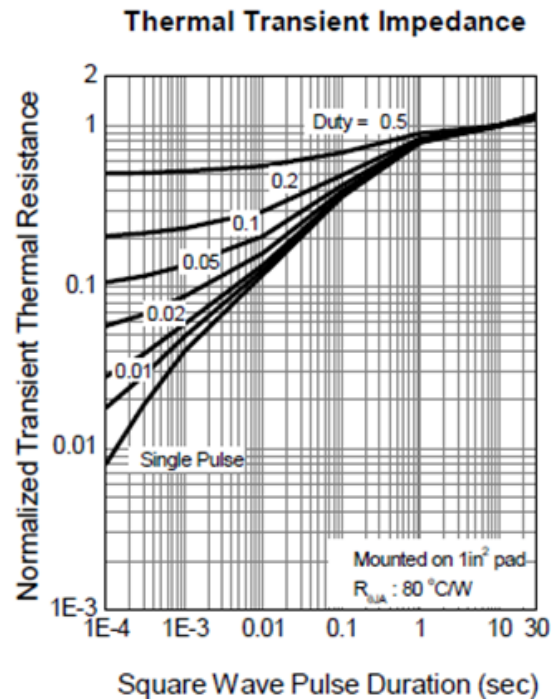
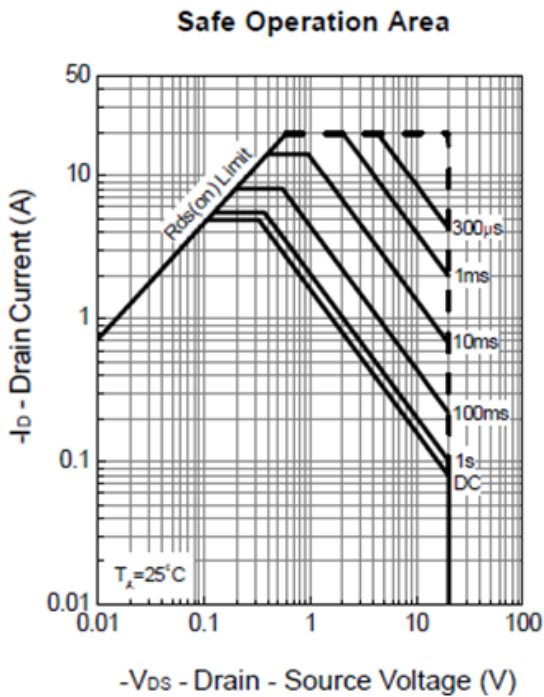
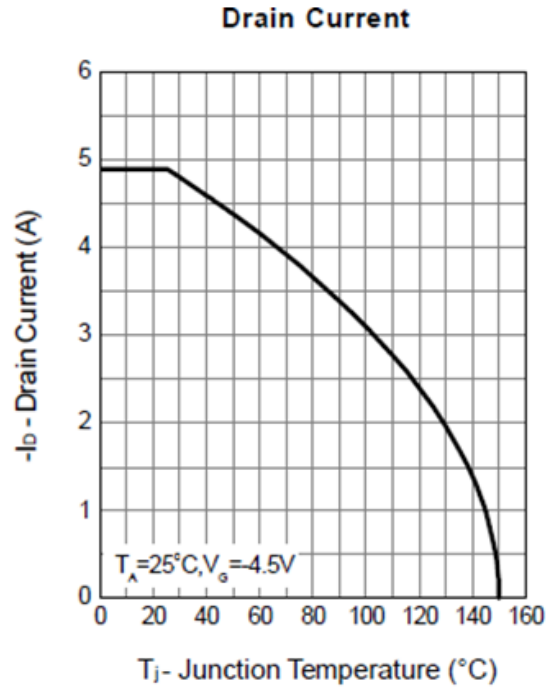
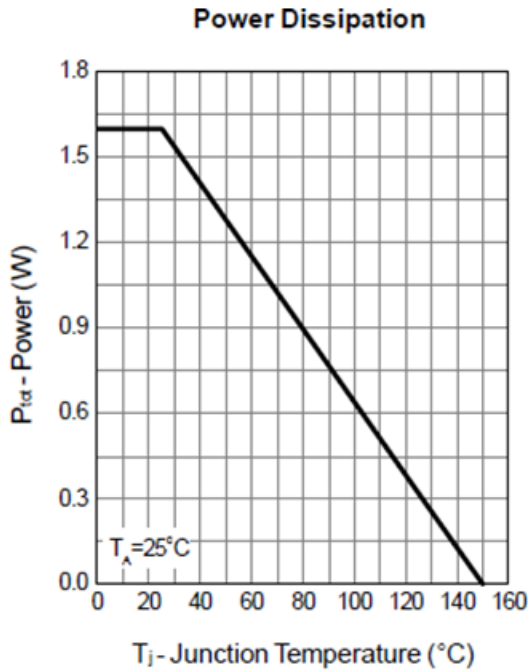
1. Pulse width limited by maximum junction temperature.
2. Pulse test: PW ≤ 300μs, duty cycle ≤ 2%.
3. For design AID only, not subject to production testing.
4. Switching time is essentially independent of operating temperature.



ACE13417B

P-Channel Enhancement Mode Power MOSFET

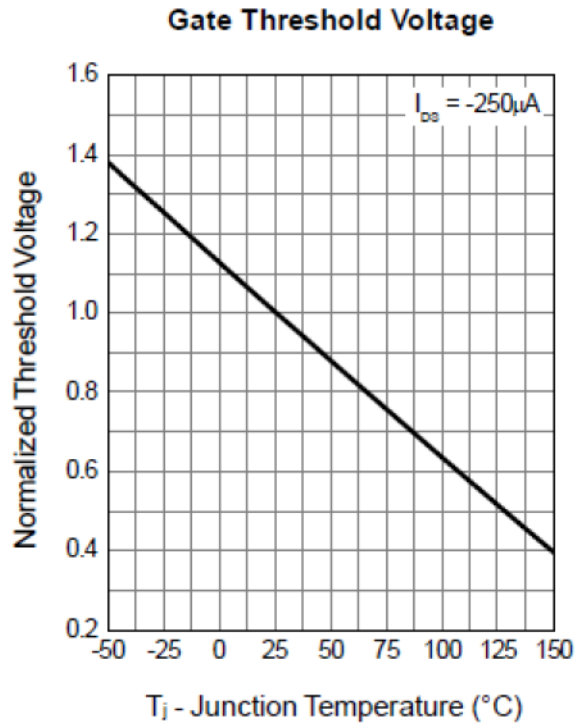
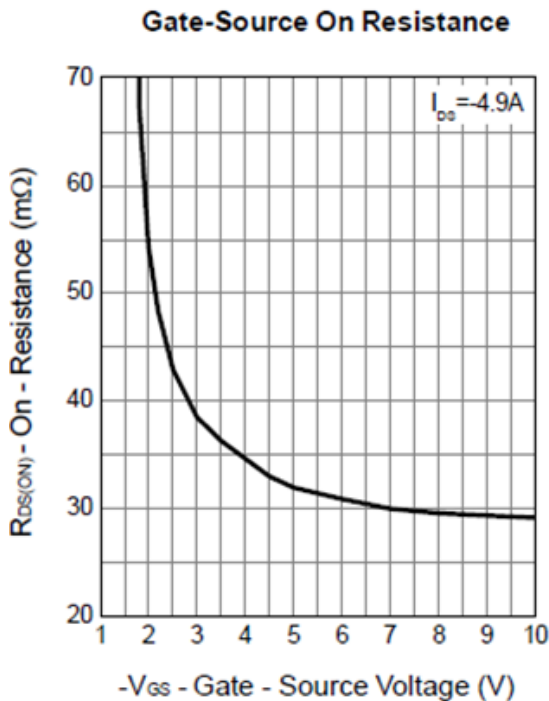
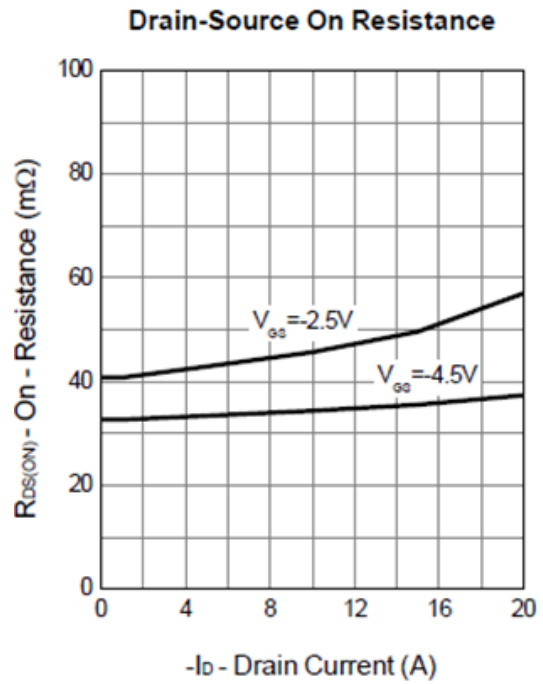
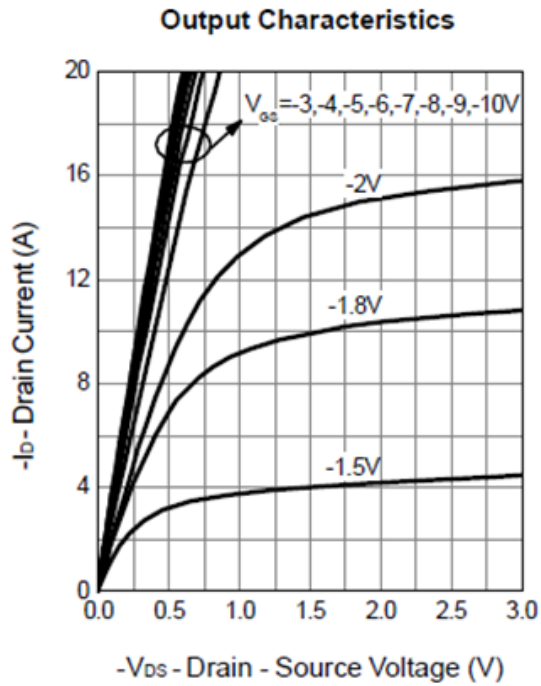
Typical Performance Characteristics





ACE13417B

P-Channel Enhancement Mode Power MOSFET

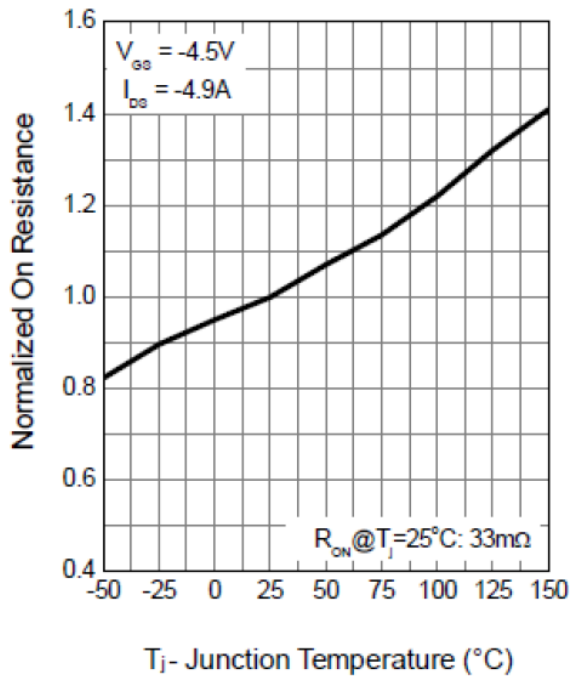




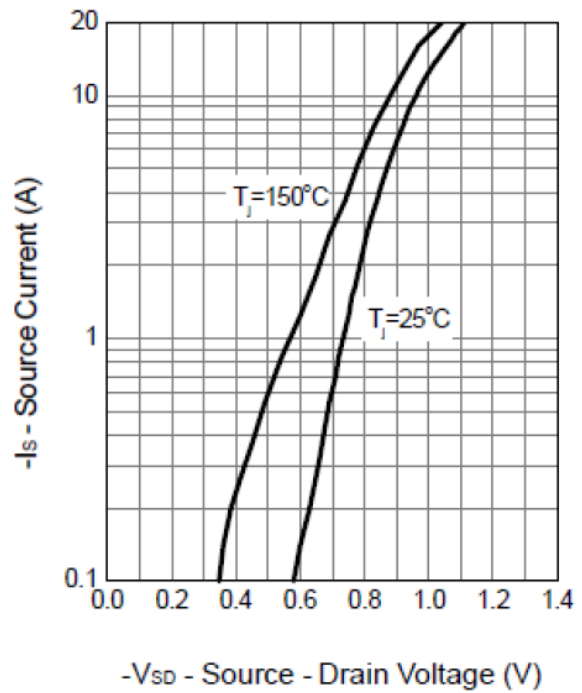
ACE13417B

P-Channel Enhancement Mode Power MOSFET

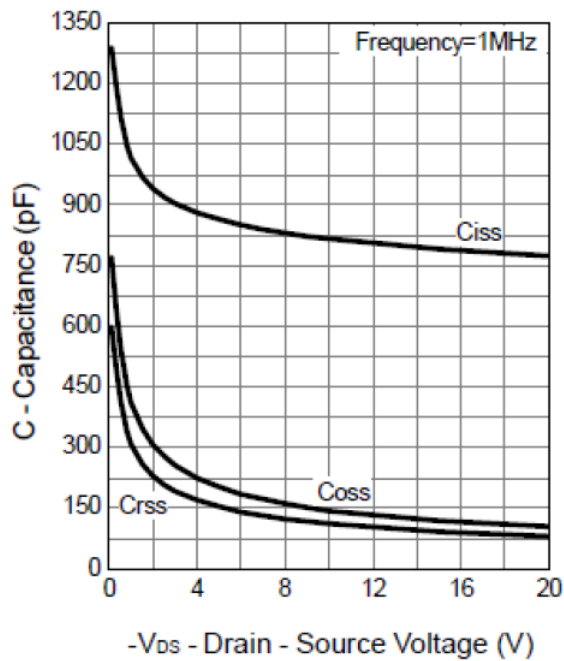
Drain-Source On Resistance



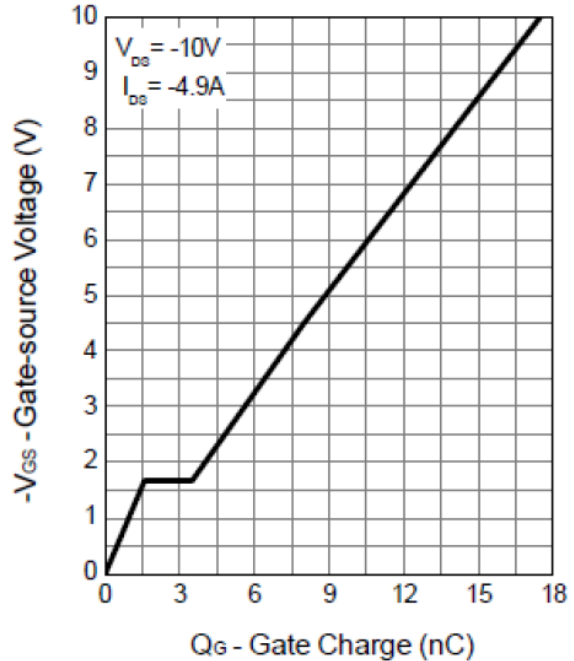
Source-Drain Diode Forward



Capacitance



Gate Charge



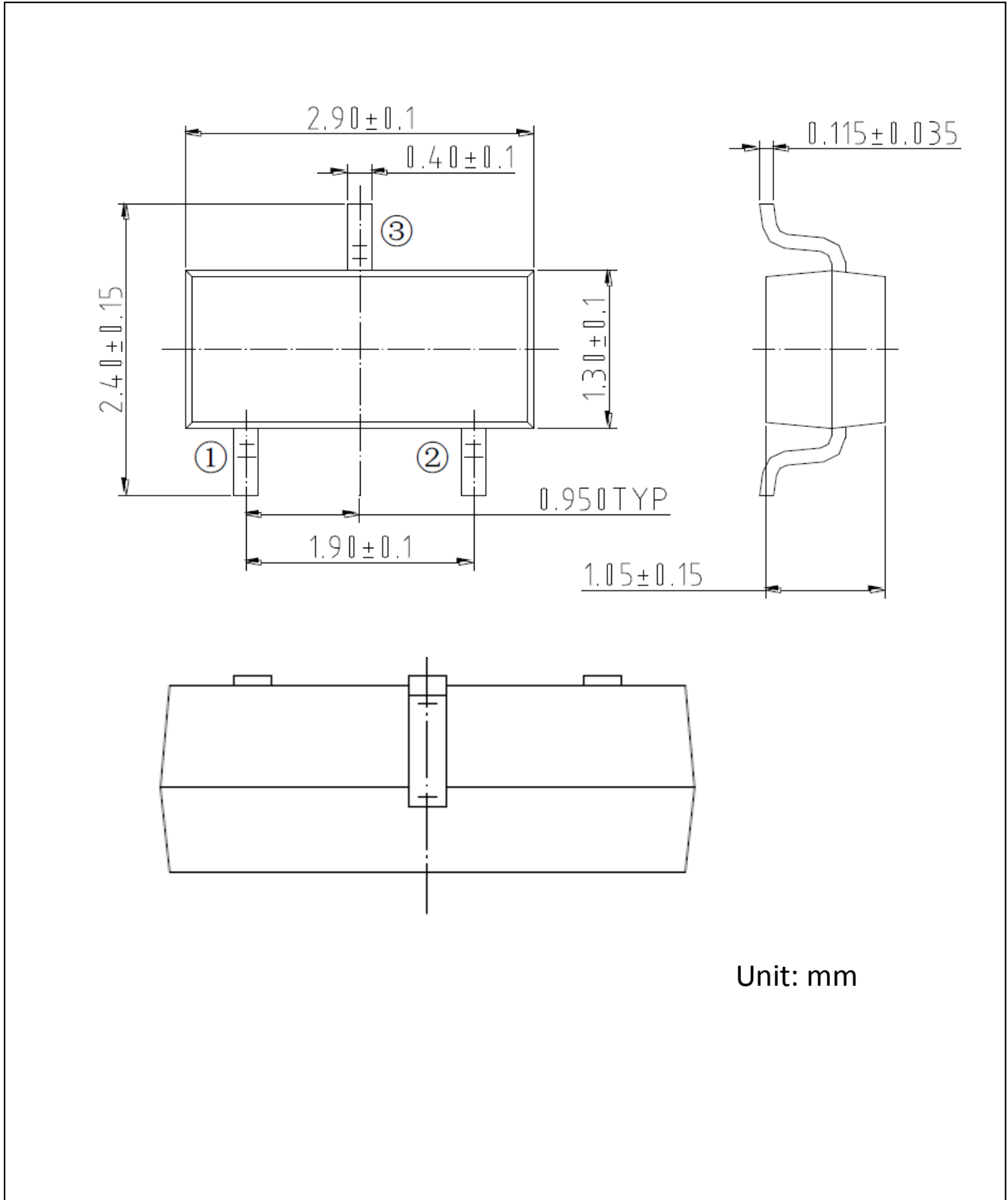


ACE13417B

P-Channel Enhancement Mode Power MOSFET

Packing Information

SOT-23-3



Unit: mm



ACE13417B

P-Channel Enhancement Mode Power MOSFET

Notes

ACE does not assume any responsibility for use as critical components in life support devices or systems without the express written approval of the president and general counsel of ACE Electronics Co., LTD. As sued herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ACE Technology Co., LTD.
<http://www.ace-ele.com/>